

	L #	Hits	Search Text	DBs	Time Stamp
1	L1	28865	((216/67-71,94) or (427/446-456,488- 491,523-531,533-540,562- 564,569-580) or (204/192.12- 192.38,298.07,298.09,298 .33,298.41) or (118/723MW- 723IR)).CCLS.) or ((134/1-1.3).CCLS.)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:16
2	L2	8285	("588"/\$.CCLS.)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:17
3	L3	184181	(waste exhaust byproduct "by-product" "by product" unreacted adj2 (gas reagent precursor))near3 (treat\$6 process\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:22
4	L4	155350	(waste exhaust byproduct "by-product" "by product" unreacted adj2 (gas reagent precursor port exit outlet))with (chamber plasma zone deposition)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:28
5	L5	8203	(3 or 4) same (plasma near3(block\$5 isolat\$5 confin\$5) baffle mesh grid perforat\$5 near2 plate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:33
6	L6	1051	5 and (plasma (corona glow electric) adj discharg\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:32

09/822,191

2

	L #	Hits	Search Text	DBs	Time Stamp
7	L7	79050	(ground\$4 potential conduct\$5 bias\$5 charg\$4) with (plasma near3(block\$5 isolat\$5 confin\$5) baffle mesh grid perforat\$5 near2 plate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:34
8	L8	54634	(ground\$4 potential conduct\$5 bias\$5 charg\$4) same (plasma near3(block\$5 isolat\$5 confin\$5) baffle mesh grid perforat\$5 near2 plate)not 7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:35
9	L9	369	6 and 7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:35
10	L10	166	6 and 8	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:35
11	L11	158	9 and (1 or 2)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:36
12	L12	211	9 not 11	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:36
13	L13	60	10 and (1 or 2)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:36

3

	L #	Hits	Search Text	DBs	Time Stamp
14	L14	106	10 not 13	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:37
15	L15	33888	3 same (heat\$5 thermal\$4 hot resistive\$4 induct\$7)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:39
16	L16	24	11 and 15	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:41
17	L18	134	11 not 16	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:42
18	L19	21	12 and 15	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:42
19	L20	190	12 not 19	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:42
20	L21	12	13 and 15	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:43

4

	L #	Hits	Search Text	DBs	Time Stamp
21	L22	48	13 not 21	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:43
22	L23	24	14 and 15	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:43
23	L24	82	14 not 23	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/06/09 12:44